IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard  http://www.ipc.org/IPC-175x  Form Typ Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and M	fg Informati	ion		
upplier Infor	mation						·							
Company name*			Company unique ID			Ţ	Unique ID Authority				Response Date*			
nsemi											2024-05-03			
Contact Name		Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stev	wards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
uthorized Repre	sentative*	Title - Representative			I	Phone - Representative*			Email - Representative*					
Product-Env-Stev	wards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Reques	ster Item Number			Mfr Item Name			Effective Date	Version	rsion Manufacturing Site		,	Weight*	UOM	Unit Type
				90V GP DUAL CE	CENTER TAP DI		2024-05-03		PE	PBB		8.706	mg	Each
	g Process Informa		Carminal Rasa	Alloy	STD-020 MS	L Pating	Pank Proce	es Rody Tam	naratura	Max Time at Peak	Tamparat	ura Numb	per of Reflow Cy	clas
		Terminal Base Alloy J-STD-02  CU Alloy 1		31D-020 MS	L Kaung		Peak Process Body Temperatu  260 C		30	secon		el of Kellow Cy	cies	
•	im (511) - amicaicu		Alloy	1			200	<u> </u> C	•	30	Secon	us 3		
omments	time at peak temperat	uro durino sol	Idorina is 10-2	M seconds										
	tion regarding materia													

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its part and the company acknowledges that Company and the Supplier share provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.048	mg	Supplier	Silicon (Si)	7440-21-3		0.048	mg
Lead Frame	2.371	mg	Supplier	Silver (Ag)	7440-22-4		0.008	mg
			Supplier	Manganese (Mn)	7439-96-5		0.019	mg
			Supplier	Silicon (Si)	7440-21-3		0.007	mg
			В	Nickel (Ni)	7440-02-0		0.995	mg
			Supplier	Iron (Fe)	7439-89-6		1.342	mg
Mold Compound-Black	6.061		Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.21	mg
			Supplier	Carbon Black (C)	1333-86-4		0.061	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.79	mg
Plating	0.206	mg	Supplier	Tin (Sn)	7440-31-5		0.206	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg